

SHENZHEN XIEJIA ELECTRONICS CO., LTD. 深圳市协佳电子有限公司		文件编号	XJ-SP-2624
		发布日期	2008年2月21日
SPECIFICATION 规格书		第 B 版	第 1 页 共 3 页
MODEL NO. 产品名称 . ST-410			
DRAWN 制订		APPV. 审批	
1. RATING (额定值) : DC 30V 0.3A			
2. ELECTRICAL CHARACTERISTICS (电气性能规格):			
ITEM 项目		TEST CONDITIONS 测试条件	PERFORMANCE 规格
2.1	CONTACT RESISTANCE 接触电阻	MEASURED AT 1KHZ SMALL CURRENT(100 mA OR LESS) 在 1KHz 微小电流(100mA 以下)测试.	100mΩ MAX. 100 毫欧以下.
2.2	INSULATION RESISTANCE 绝缘电阻	APPLY A VOLTAGE OF 500V DC FOR 1 MIN. TO FOLLOWING PORTIONS AFTER WHICH MEASUREMENT SHALL BE MADE: (1) BETWEEN BODY AND TERMINAL (2) BETWEEN TERMINAL NOT TO BE CONTACTED (3) BETWEEN TERMINAL NOT TO BE CONTACTED WHEN PLUG IS INSERTED. 输入 500V DC 电压 1 分钟,按以下接触方法测试: (1) 插座体与排脚之间. (2) 不接触的排脚之间. (3) 插头插入时不接触排脚之间.	100MΩ MIN. 100 兆欧以上.
2.3	DIELECTRIC STRENGTH 耐电压	AC 500V rms(50-60Hz)FOR 1 MIN TRIP CURRENT:0.5 mA (1) BETWEEN BODY AND TERMINAL (2) BETWEEN TERMINAL NOT TO BE CONTACTED (3) BETWEEN TERMINAL NOT TO BE CONTACTED WHEN PLUG IS INSERTED. 输入 AC 500V(50-60Hz)电压,1 分钟感度电流为 0.5mA,按以下接触方法测试: (1) 插座体与排脚之间. (2) 不接触的排脚之间. (3) 插头插入时不接触排脚之间.	WITHOUT DAMAGE TO PARTS ARCING OR BREAKDOWN ETC. 没有绝缘破坏等异常.
3. MECHANICAL CHARACTERISTICS (机械性能规格)			
ITEM 项目		TEST CONDITIONS 测试条件	PERFORMANCE 规格
3.1	INSERTION FORCE 插入力度	MEASUREMENT SHALL BE MADE AFTER INSERTION AND DISCONNECTING USING STANDARD PLUG GAUGE 3 TIMES. 依据标准的 PLUG GAUGE 做 3 次拔插后测定.	(0.3~3Kgf)
	WITHDRAWAL FORCE 拔出力度	MEASUREMENT SHALL BE MADE AFTER INSERTION AND WITHDRAWAL USING STANDARD PLUG GAUGE 3 TIMES. 依据标准的 PLUG GAUGE 做 3 次拔插后测定.	(0.3~3Kgf)
3.2	TERMINAL STRENGTH 端子强度	A STATIC LOAD OF 300gf SHALL BE APPLIED TO THE TERMINAL FOR 15 SEC.IN ANY DIRECTION 在排脚前端任意一个方向加 300gf 力度测试,时间为 15 秒.	THERE SHALL BE NO DAMAGE TO THE TERMINAL SUCH AS CRACKS, LOOSENESS OR PLAY. ELECTRICAL AND MECHANICAL CHARACTERISTICS SHALL BE SATISFIED. 在排脚中没有裂开.松动等异常.满足于机械.电器性能.

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3.3	PRACTICAL TEMPERATURE RANGE 使用温度范围	-16℃~+60℃. 在-16℃~+60℃温度内使用。	
4. DURABILITY (耐久性):			
	ITEM 项目	TEST CONDITIONS 测试条件	PERFORMANCE 规格
4.1	LIFE TEST 寿命试验	WITHOUT LOAD: CONNECTION AND DISCONNECTION SHALL BE MADE WITH THE MATING PLUGS AND JACKS FOR 5,000 CYCLES AT A SPEED OF 15 TO 18 CYCLES/MIN. 无负荷: 将结合了的标准 plug(尽量要近于中心的)在 1 分钟内以 15~18 的速度,进行 5,000 次插入、拔出。	(1) CONTACT RESISTANCE SHALL BE 200mΩ MAX. (2) MECHANICAL AND ELECTRICAL CHARACTERISTICS SHALL BE SATISFIED. (1) 接触电阻不能超于 200mΩ. (2) 其它、满足于机械、电器性能。
4.2	HEAT TEST 耐热试验	THE SWITCH SHALL BE STORED AT A TEMPERATURE OF 85±2℃ FOR 96 HOURS AND THEN IT SHALL BE SUBJECTED TO THE CONTROLLED RECOVERY CONDITIONS FOR 1 HOUR AFTER WHICH MEASUREMENT SHALL BE MADE. 放置在温度 85±2℃中测试 96 小时后,再放置正常室温中 1 小时来测定	
4.3	COLD TEST 耐冷试验	THE SWITCH SHALL BE STORED AT A TEMPERATURE OF -25±3℃ FOR 96 HOURS AND THEN IT SHALL BE SUBJECTED TO THE CONTROLLED RECOVERY CONDITIONS FOR 1 HOUR AFTER WHICH MEASUREMENT SHALL BE MADE. 放置在温度-25±3℃中 96 小时后,再放置常温常湿中 1 小时来测定。	THERE SHALL BE NO DAMAGE ON APPEARANCE. MECHANICAL AND ELECTRICAL CHARACTERISTICS SHALL BE SATISFIED. 外观无异常, 满足于机械, 电器性能。
4.4	HUMIDITY TEST 潮湿试验	THE SWITCH SHALL BE STORED AT TEMPERATURE OF 40±2℃ AND HUMIFITY OF 90% TO 96% FOR 96 HOURS, THEN THE SWITCH SHALL BE MAINTAINED AT STANDARD ATMOSPHERIC CONDITION FOR 1 Hr FOR OTHER PROCEDURES BE MADE. 放置 40±2℃. 的相对湿度为 90~96%环境中 96 小时后,再将样版放在正常环境 1 小时后进行测试。	

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4.5	STANDARD ATMOSPHERIC CONDITIONS 测试标准状态	<p>UNLESS OTHERWISE SPECIFIED. THE STANDARD RANGE OF ATMOSPHERIC CONDITIONS FOR MAKING MEASUREMENTS AND TESTS ARE AS FOLLOWINGS: AMBIENT TEMPERATURE : 5°C TO 35°C RELATIVE HUMIDITY : 45% TO 85% AIR PRESSURE : 86Kpa TO 106Kpa 在没有指定的情况下测试温度、湿度、气压如下: (1) 温度为 5~35°C. (2) 湿度为 45%~85%. (3) 气压为 86Kpa~106Kpa.</p>										
4.6	SOLDERABILITY TEST 可焊性试验	<p>THE TOP OF THE TERMINALS SHALL BE DIPPED 2mm IN THE SOLDER BATH OF 230±5°C FOR 3±0.5 SECONDS 端子顶部被浸入锡池中 2mm 深, 温度为 230±5°C, 时间为 3±0.5 秒。</p> <p>THE AREA OF SOLDERING. SHOULD BE OVER 75% 焊接面积要有 75%以上。</p>										
4.7	RESISTANCE TO SOLDERING HEAT TEST 耐焊性试验	<p>(1). TEMPERATURE AND IMMERSING TIME 温度及浸锡时间</p> <table border="1"> <thead> <tr> <th></th> <th>TEMPERATURE 温度 (°C)</th> <th>TIME 时间 (s)</th> </tr> </thead> <tbody> <tr> <td>DIP SOLDERING 浸锡</td> <td>260±5</td> <td>3±1</td> </tr> <tr> <td>MANUAL SOLDERING 手焊</td> <td>360±10</td> <td>3±1</td> </tr> </tbody> </table> <p>(2) IMMERSION DEPTH: IMMERSION DEPTH UP TO THE SURFACE OF THE BOARD THICKNESS OF PRINTED WIRING BOARD 1.6mm. 浸锡深度: 浸锡深度至基板(PCB)表面, 基板厚度为 1.6mm.</p> <p>WITHOUT DEFORMATION OF CASE OR EXCESSIVE LOOSENESS OF TERMINALS MECHANICAL AND ELECTRICAL CHARACTERISTICS SHALL BE SATISFIED. 本体无变形, 能满足于机械、电器性能。</p>			TEMPERATURE 温度 (°C)	TIME 时间 (s)	DIP SOLDERING 浸锡	260±5	3±1	MANUAL SOLDERING 手焊	360±10	3±1
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